

Annealing of the vacancy-oxygen and divacancy-oxygen complexes in silicon

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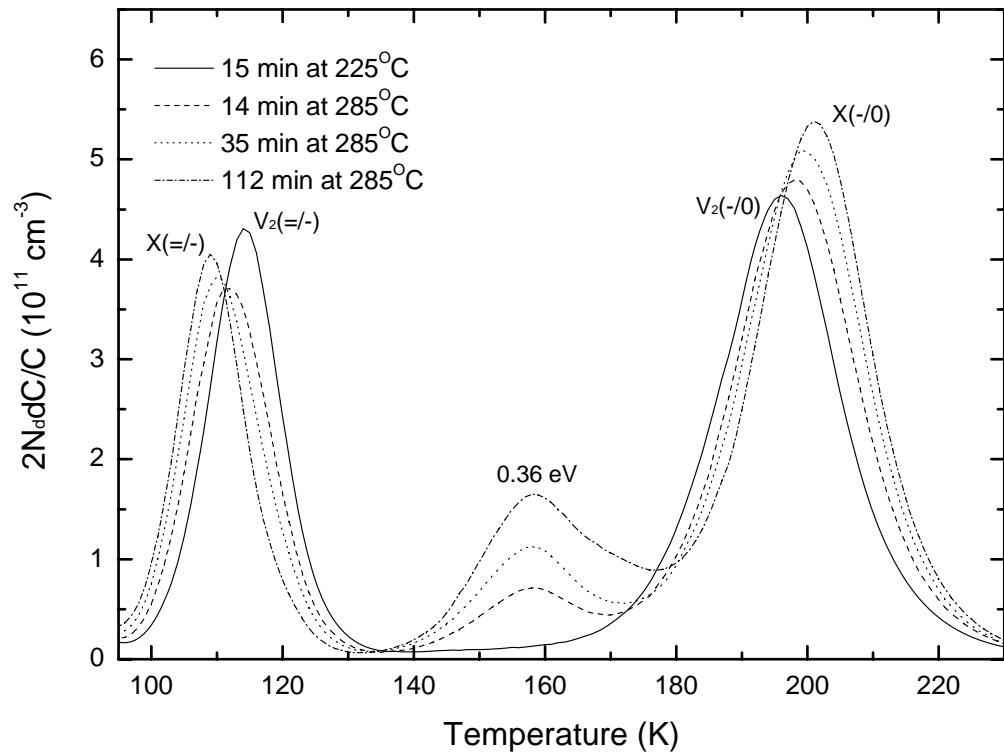


Background



- During irradiation we get:
 - $V + O_i \rightarrow VO$
 - $V + V \rightarrow V_2$
(V_2 is also produced directly)
- For higher doses:
 - $V + VO \rightarrow V_2O$ Basis for *I*-level identification
- Another channel for V_2O formation:
 - $V_2 + O_i \rightarrow V_2O$ Basis for *X*-level identification

Background



- X was identified as V_2O
- V_2 migrates:
 - $\text{V}_2 + \text{O}_i \rightarrow \text{V}_2\text{O}$

M. Mikelsen, E. V. Monakhov, G. Alfieri, B. S. Avset, and B. G. Svensson
Phys. Rev. B 72, 195207 (2005)

Experiment

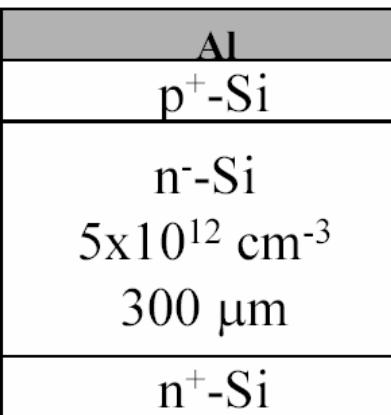
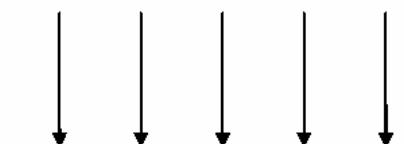


Survey of the samples used in the study:

Sample	Doping (P/cm ³)	Carbon (cm ⁻³)	Oxygen (cm ⁻³)
MCZ-Si	5.5×10^{12}	$\leq 10^{16}$	$(5-10) \times 10^{17}$
DOFZ-Si	5.0×10^{12}	$(2-4) \times 10^{16}$	$(2-3) \times 10^{17}$

- DOFZ = Diffusion-Oxygenated Float-Zone Si
- MCZ = Magnetic Czochralski
- **Experimental method:**
 - DLTS
 - Pre-annealing to insure a $V_2 \rightarrow V_2O$ transformation.
 - Isothermal annealing in the range 275-355 °C.

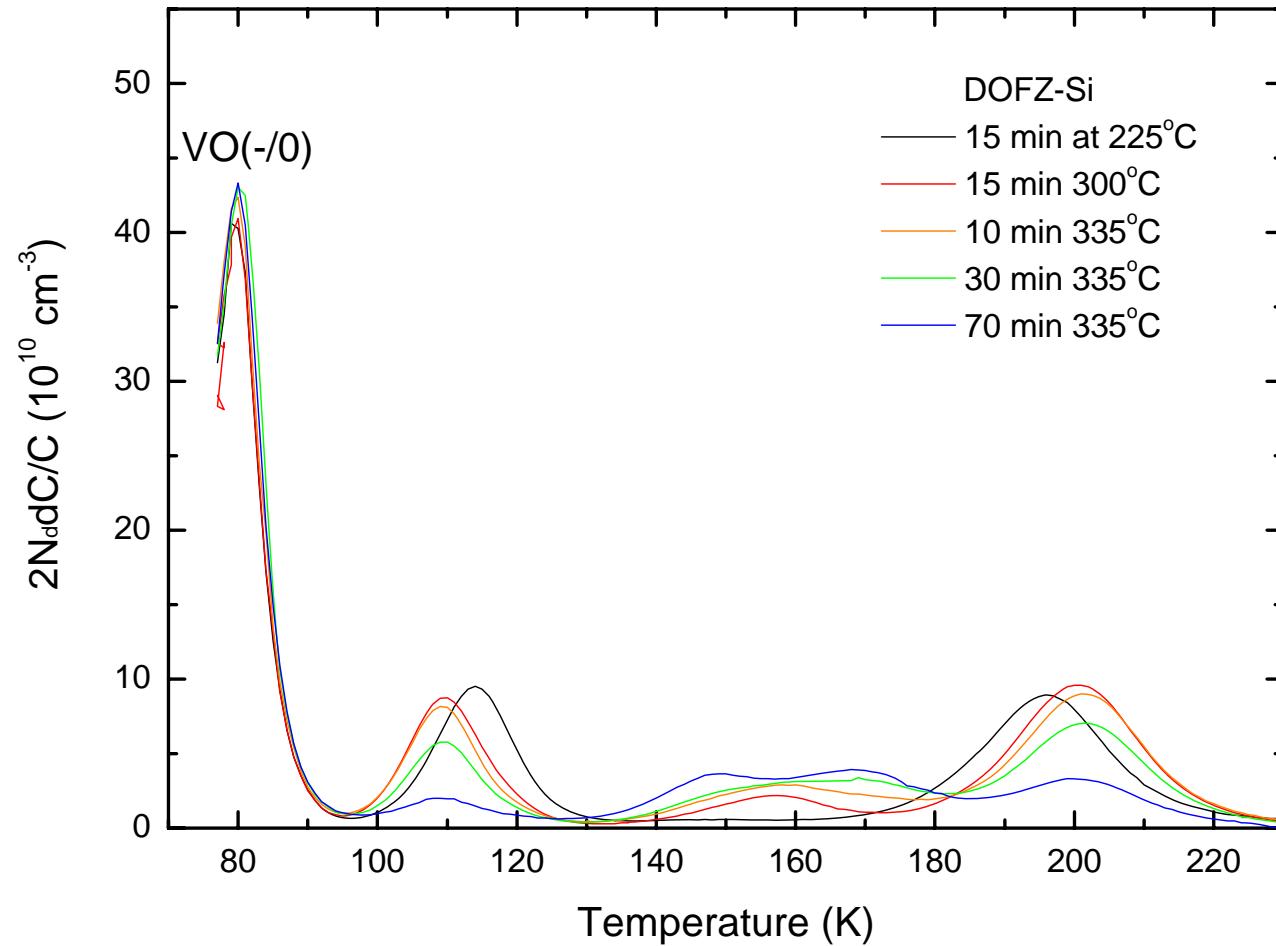
6 MeV electrons



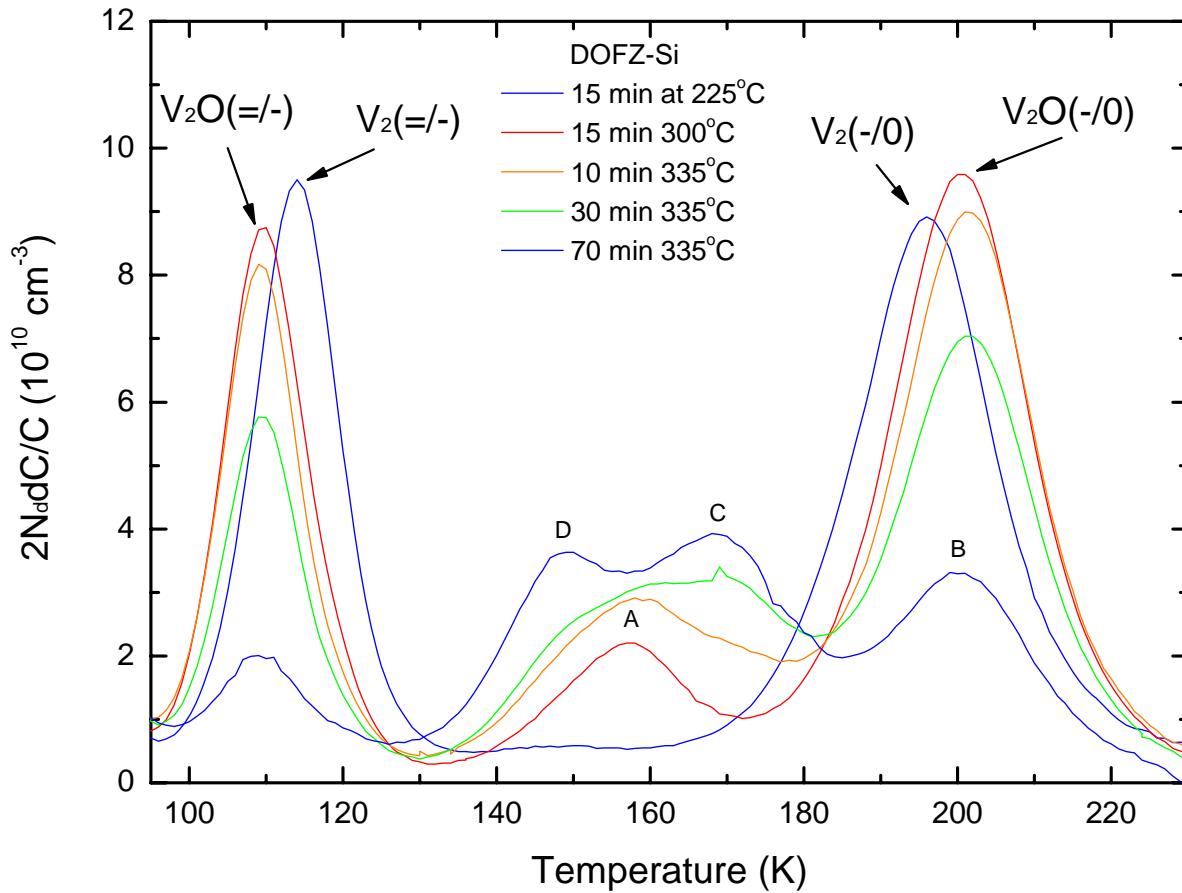
Dose: $2 - 5 \times 10^{12} \text{ cm}^{-2}$

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Results: DOFZ - Si



Results: DOFZ - Si



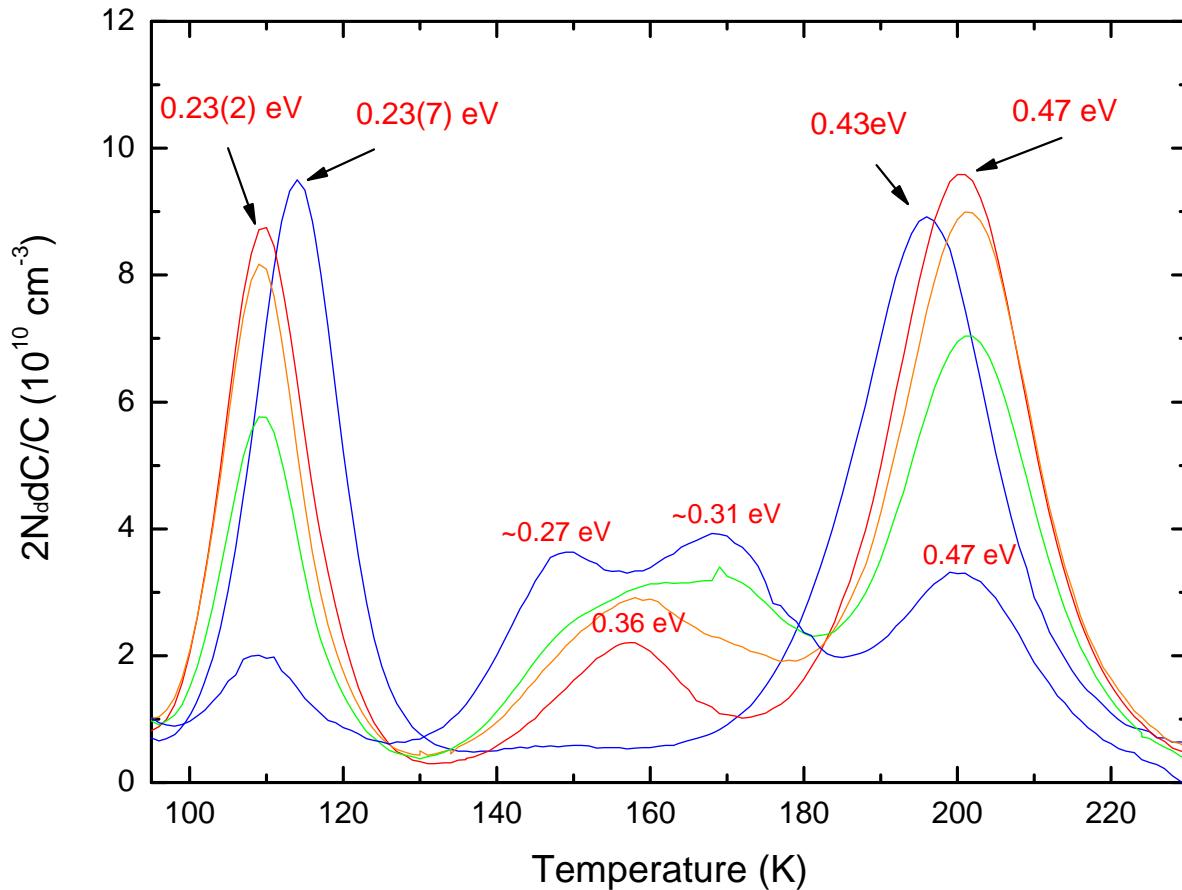
- Other levels observed:
 - A at ~ 157 K (*)
 - B at ~ 200 K
 - Similar electrical parameters as $V_2O(-/0)$.
 - C at ~ 175 K
 - D at ~ 157 K

(*) To be discussed in:

"On the formation of the L-center in silicon during heat treatment in the temperature range 205 to 285°C"

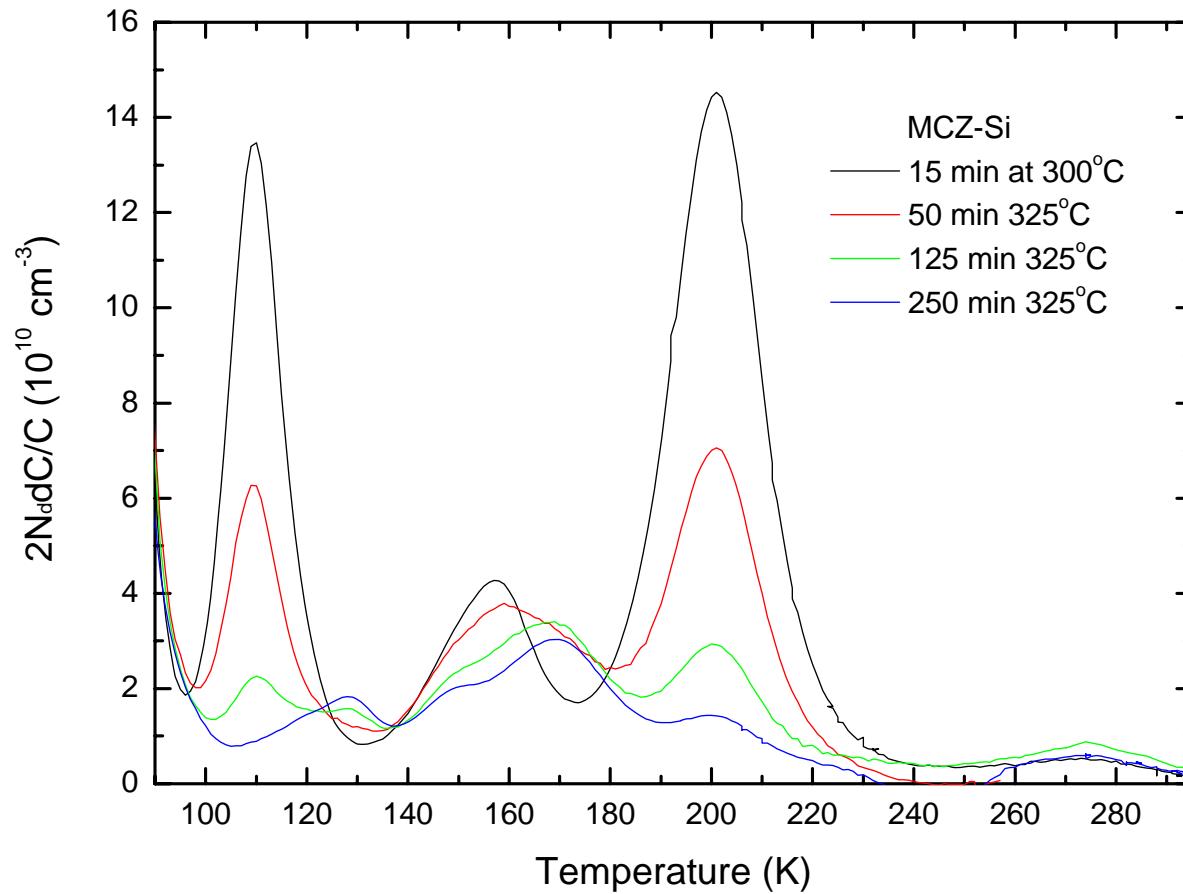
M. Mikelsen, E. V. Monakhov, B. S. Avset, B. G. Svensson
To be published in "Physica scripta"

Results: DOFZ - Si



- The activation enthalpies for peak C and D were obtained by using a computer program that fits the spectrum to a sum of single peaks.

Results: MCZ Si

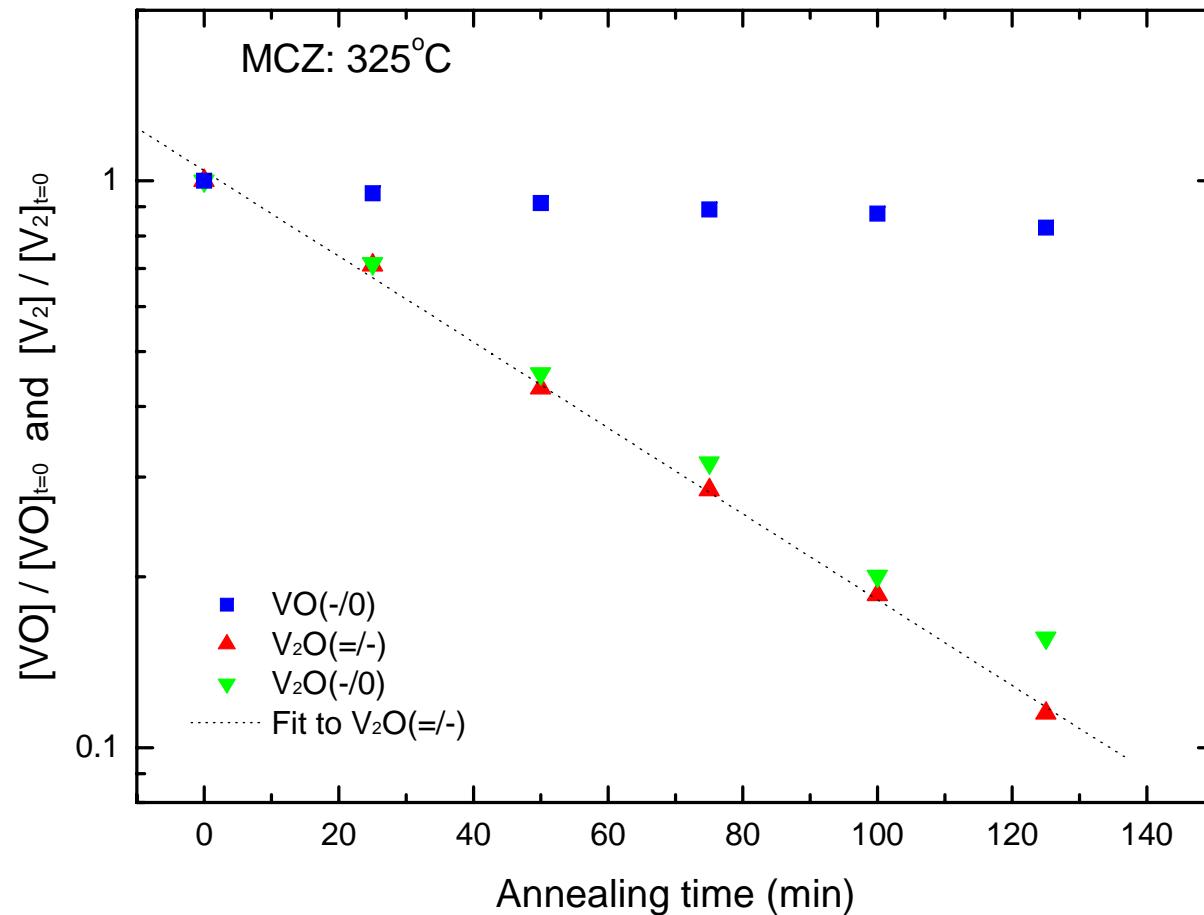


- MCZ-Si behaves similar to DOFZ
 - But the area between the two V_2O peaks looks a little bit different. (No D-peak)



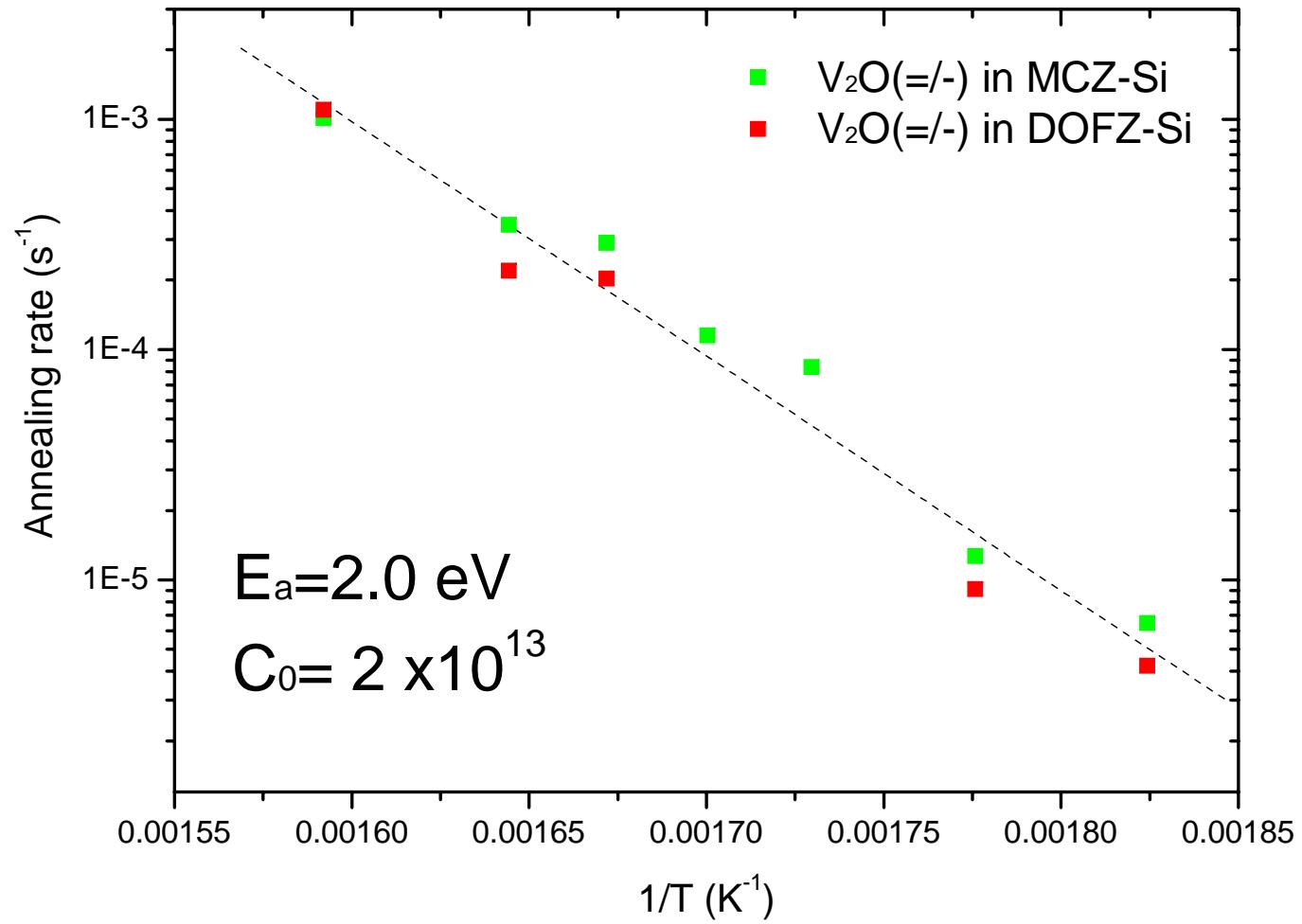
Results: V₂O annealing

Example:



- The annealing of V₂O(=/-) exhibits first order kinetics.
 - For both MCZ and DOFZ.
 - For all annealing temperatures in the range 275 - 355 °C.
 - The kinetics for V₂O(-/0) is affected by overlapping level.

Results: V₂O annealing



The V_2O annealing mechanism



- It is improbable that V_2O anneals by migration and trapping.
 - Since O_i is the main impurity, one would expect V₂O₂ to form.
 - V₂O₂ is believed to be electrically active with two acceptor centers similar to V₂ and V₂O.
- V₂O does not anneal by interacting with migrating oxygen dimers.
 - The diffusivity of O₂ is too low by a factor 10⁴.

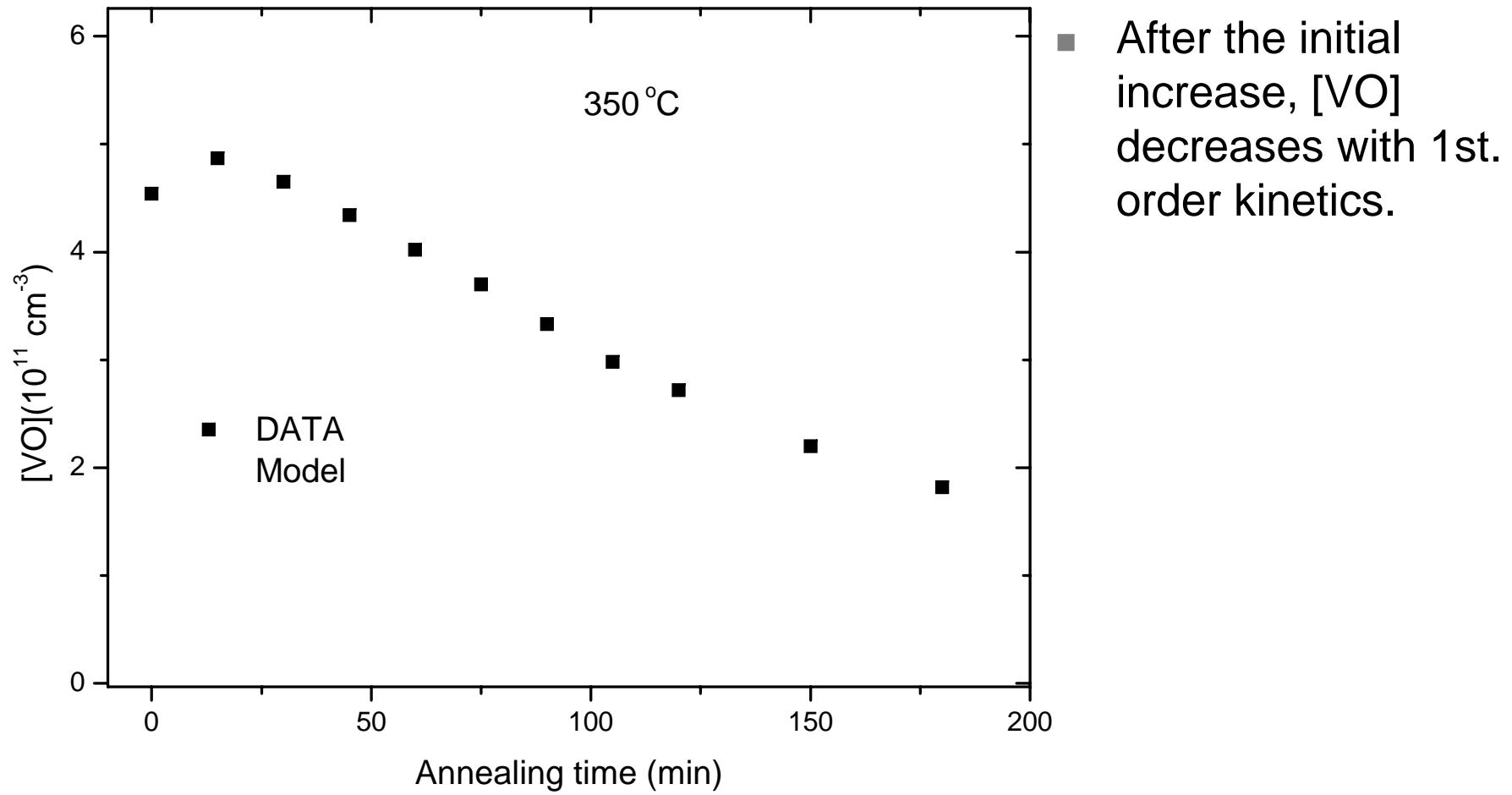


The V₂O annealing mechanism

- A prefactor, c_0 , in the $10^{12} – 10^{13}$ range is expected for dissociation.
 - The experimental value is in this range taking in regard the uncertainty.
 - If dissociation were to occur we would expect an increase in VO;
 $V_2O \rightarrow V + VO$

.... So we must investigate the VO annealing, to check if it really is dissociation.

Results: VO annealing (DOFZ)





A model for defect annealing

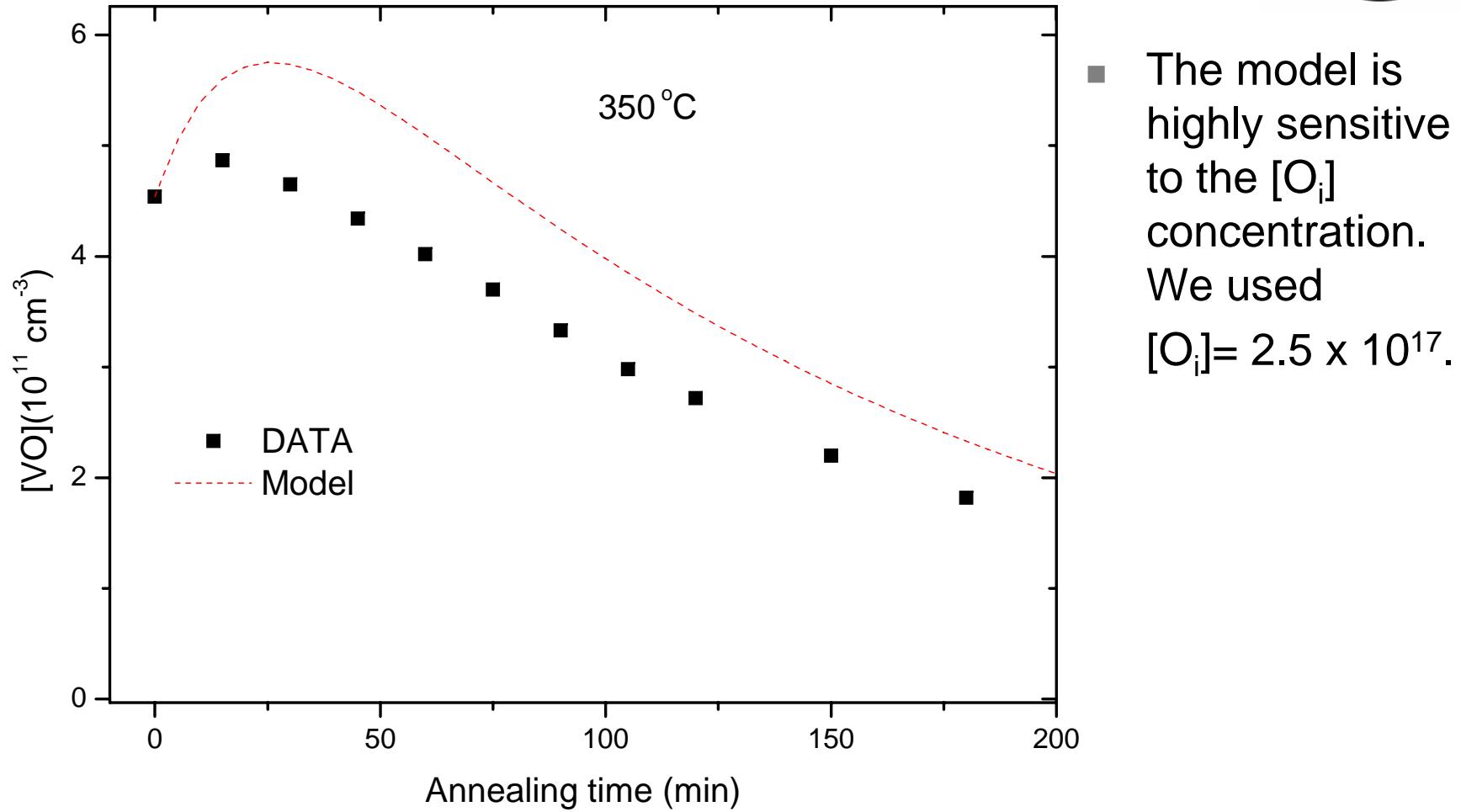
- The reactions

- $V_2O \rightarrow VO + V$ (dissociation)
 - $V + O_i \rightarrow VO$ (migration of V)
 - $VO + O_i \rightarrow VO_2$ (migration of VO)
 - $VO \rightarrow V + O_i$ (dissociation)
 - $VO + V \rightarrow V_2O$ (migration of V)

- The diff-equations

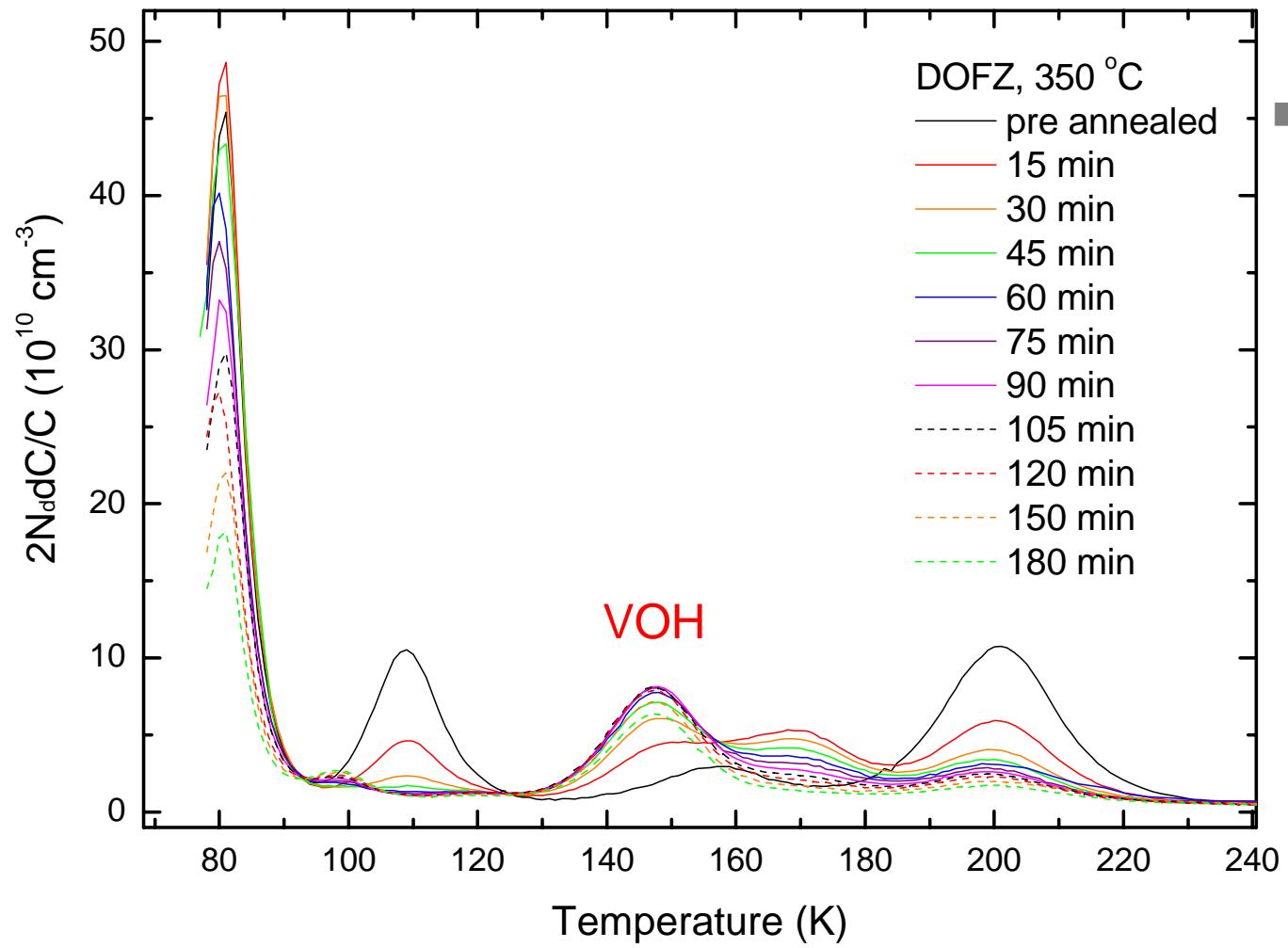
- $\frac{d[VO]}{dt} = - C_{diss_V2O}(T) [V_2O] + 4\pi R D_V(T) [V] [VO]$
 - $\frac{d[VO]}{dt} = C_{diss_V2O}(T) [V_2O] + 4\pi R D_V(T) [V] [O_i] - 4\pi R D_{VO}(T) [VO] [O_i]$
 $- C_{diss_VO}(T) [VO] - 4\pi R D_V(T) [V] [VO]$
 - $\frac{d[V]}{dt} = C_{diss_V2O}(T) [V_2O] + C_{diss_VO}(T) [VO] - 4\pi R D_V(T) [V] [O_i]$
 $- 4\pi R D_V(T) [V] [VO]$

Results: VO annealing (DOFZ)



- The model is highly sensitive to the $[O_i]$ concentration. We used $[O_i] = 2.5 \times 10^{17}$.

Results



Hydrogen
may interact
with VO.



Summary

- The V_2O defect anneals with an activation energy, E_a , of ~ 2.0 eV and a prefactor $\sim 2 \times 10^{13} \text{ s}^{-1}$.
- Dissociation is the likely annealing mechanism for V_2O .
- A model that includes VO and V_2O dissociation and VO migration and trapping describes the observed annealing kinetics well.